Preferred Device

Sensitive Gate Triacs

Silicon Bidirectional Thyristors

Designed for high volume, low cost, industrial and consumer applications such as motor control; process control; temperature, light and speed control.

- Small Size Surface Mount DPAK Package
- Passivated Die for Reliability and Uniformity
- Four-Quadrant Triggering
- Blocking Voltage to 600 V
- On–State Current Rating of 4.0 Amperes RMS at 93°C
- Low Level Triggering and Holding Characteristics
- Device Marking: Device Type with "M" truncated, e.g., MAC4DHM: AC4DHM, Date Code

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit
Peak Repetitive Off–State Voltage ⁽¹⁾ (T _J = -40 to 110°C, Sine Wave, 50 to 60 Hz, Gate Open)	V _{DRM,} VRRM		Volts
MAC4DHM		600	
On–State RMS Current (Full Cycle Sine Wave, 60 Hz, T _C = 93°C)	lT(RMS)	4.0	Amps
Peak Non-Repetitive Surge Current (One Full Cycle, 60 Hz, T _J = 110°C)	ITSM	40	Amps
Circuit Fusing Consideration (t = 8.3 msec)	I ² t	6.6	A ² sec
Peak Gate Power (Pulse Width ≤ 10 μsec, T _C = 93°C)	PGM	0.5	Watts
Average Gate Power (t = 8.3 msec, T _C = 93°C)	P _{G(AV)}	0.1	Watts
Peak Gate Current (Pulse Width ≤ 10 μsec, T _C = 93°C)	I _{GM}	0.2	Amps
Peak Gate Voltage (Pulse Width ≤ 10 μsec, T _C = 93°C)	VGМ	5.0	Volts
Operating Junction Temperature Range	TJ	-40 to 110	°C
Storage Temperature Range	T _{stg}	-40 to 150	°C

⁽¹⁾ V_{DRM} and V_{RRM} for all types can be applied on a continuous basis. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the device are exceeded.



ON Semiconductor

http://onsemi.com

TRIACS 4.0 AMPERES RMS 600 VOLTS





STYLE 6





D-PAK CASE 369A STYLE 6

PIN ASSIGNMENT			
1	Main Terminal 1		
2	Main Terminal 2		
3	Gate		
4	Main Terminal 2		

ORDERING INFORMATION

Device	Package	Shipping
MAC4DHMT4	DPAK 369A	16mm Tape and Reel (2.5K/Reel)
MAC4DHM-1	DPAK 369	75 Units/Rail

Preferred devices are recommended choices for future use and best overall value.

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance — Junction to Case — Junction to Ambient — Junction to Ambient ⁽¹⁾	R _Ð JC R _Ð JA R _Ð JA	3.5 88 80	°C/W
Maximum Lead Temperature for Soldering Purposes(2)	TL	260	°C

⁽¹⁾ Surface mounted on minimum recommended pad size.

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise noted; Electricals apply in both directions)

Characteristic	Symbol	Min	Тур	Max	Unit	
OFF CHARACTERISTICS						
Peak Repetitive Blocking Current (V_D = Rated V_{DRM} , V_{RRM} ; Gate Open) T_J = 25°C T_J = 110°C	I _{DRM,} I _{RRM}		_	0.01 2.0	mA	
ON CHARACTERISTICS	•	•	•	•		
Peak On–State Voltage ⁽¹⁾ (I _{TM} = ±6.0 A)	VTM	_	1.3	1.6	Volts	
Gate Trigger Current (Continuous dc) (V _D = 12 V, R _L = 100 Ω) MT2(+), G(+) MT2(+), G(-) MT2(-), G(-) MT2(-), G(+)	^I GT		1.8 2.1 2.4 4.2	5.0 5.0 5.0 10	mA	
Gate Trigger Voltage (Continuous dc) (V_D = 12 V, R_L = 100 Ω) MT2(+), G(+) MT2(+), G(-) MT2(-), G(-) MT2(-), G(+)	VGT	0.5 0.5 0.5 0.5	0.62 0.57 0.65 0.74	1.3 1.3 1.3 1.3	Volts	
Gate Non–Trigger Voltage (Continuous dc) $ (V_D = 12 \text{ V, R}_L = 100 \ \Omega, \ T_J = 110^{\circ}\text{C}) $ All Four Quadrants	V _{GD}	0.1	0.4	_	Volts	
Holding Current (V _D = 12 V, Gate Open, Initiating Current = ±200 mA)	lн	_	1.5	15	mA	
$ \begin{array}{llllllllllllllllllllllllllllllllllll$	ΙL	_ _ _	1.75 5.2 2.1 2.2	10 10 10 10	mA	

DYNAMIC CHARACTERISTICS

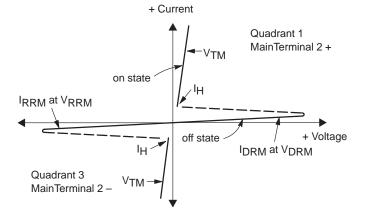
Characteristic	Symbol	Min	Тур	Max	Unit
Rate of Change of Commutating Current $(V_D=200~V,~I_{TM}=1.8~A,~Commutating~dv/dt=1.0~V/\mu sec,~T_J=110^{\circ}C,~f=250~Hz,~CL=5.0~\mu fd,~LL=80~mH,~RS=56~\Omega,~CS=0.03~\mu fd)~With~snubber~see~Figure~11$	di/dt(c)	ı	3.0	_	A/ms
Critical Rate of Rise of Off–State Voltage (VD = 0.67 X Rated VDRM, Exponential Waveform, Gate Open, TJ = 110°C)	dv/dt	20	_	_	V/μs

⁽¹⁾ Pulse Test: Pulse Width \leq 2.0 msec, Duty Cycle \leq 2%.

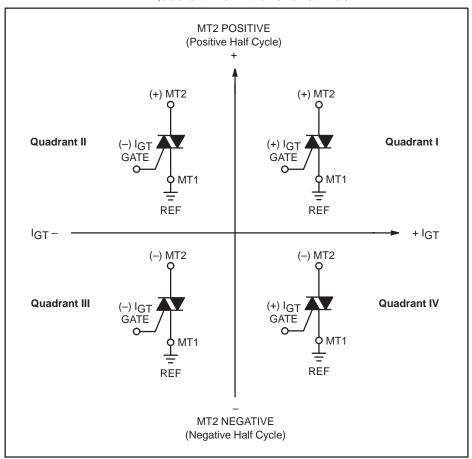
^{(2) 1/8&}quot; from case for 10 seconds.

Voltage Current Characteristic of Triacs (Bidirectional Device)

Symbol	Parameter
V _{DRM}	Peak Repetitive Forward Off State Voltage
IDRM	Peak Forward Blocking Current
VRRM	Peak Repetitive Reverse Off State Voltage
IRRM	Peak Reverse Blocking Current
V _{TM}	Maximum On State Voltage
lΗ	Holding Current



Quadrant Definitions for a Triac



All polarities are referenced to MT1.

With in-phase signals (using standard AC lines) quadrants I and III are used.

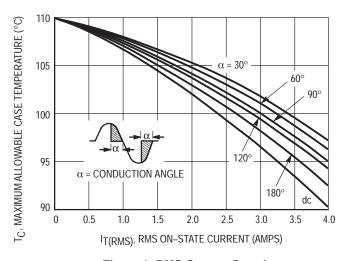


Figure 1. RMS Current Derating

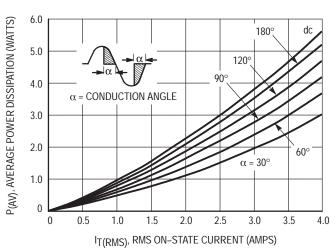


Figure 2. On-State Power Dissipation

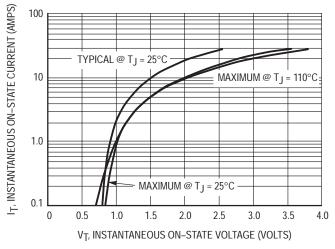


Figure 3. On-State Characteristics

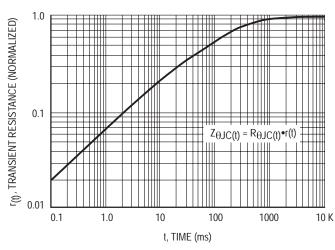


Figure 4. Transient Thermal Response

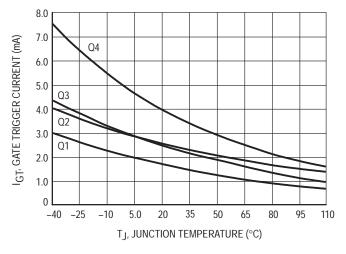


Figure 5. Typical Gate Trigger Current versus Junction Temperature

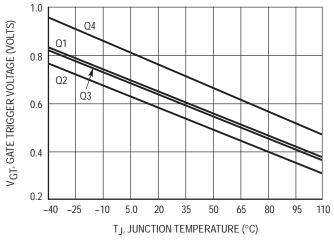


Figure 6. Typical Gate Trigger Voltage versus
Junction Temperature

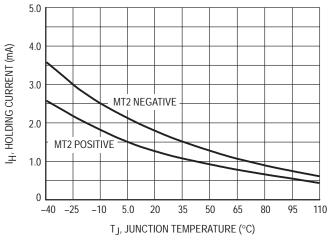


Figure 7. Typical Holding Current versus Junction Temperature

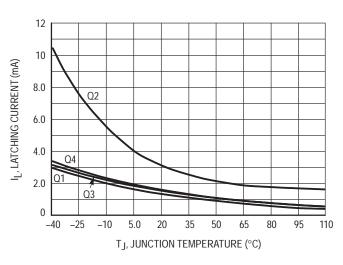


Figure 8. Typical Latching Current versus Junction Temperature

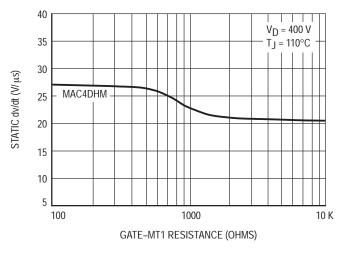


Figure 9. Minimum Exponential Static dv/dt versus Gate-MT1 Resistance

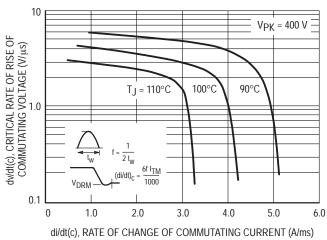
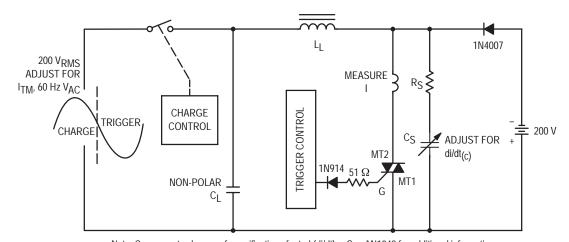


Figure 10. Typical Critical Rate of Rise of Commutating Voltage



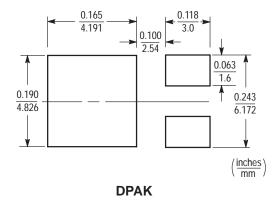
Note: Component values are for verification of rated $(di/dt)_C$. See AN1048 for additional information.

Figure 11. Simplified Test Circuit to Measure the Critical Rate of Rise of Commutating Current (di/dt)_C

MINIMUM RECOMMENDED FOOTPRINT FOR SURFACE MOUNTED APPLICATIONS

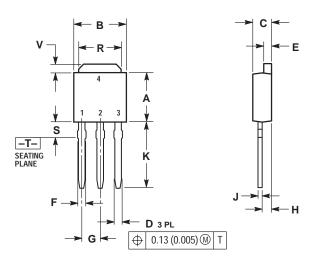
Surface mount board layout is a critical portion of the total design. The footprint for the semiconductor packages must be the correct size to insure proper solder connection

interface between the board and the package. With the correct pad geometry, the packages will self align when subjected to a solder reflow process.



PACKAGE DIMENSIONS

D-PAK CASE 369-07 ISSUE L



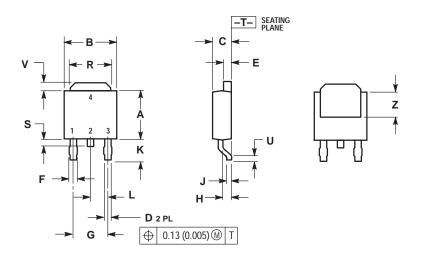
NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 CONTROLLING DIMENSION: INCH.

	INC	HES	MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.235	0.250	5.97	6.35	
В	0.250	0.265	6.35	6.73	
С	0.086	0.094	2.19	2.38	
D	0.027	0.035	0.69	0.88	
E	0.033	0.040	0.84	1.01	
F	0.037	0.047	0.94	1.19	
G	0.090 BSC		2.29 BSC		
Н	0.034	0.040	0.87	1.01	
J	0.018	0.023	0.46	0.58	
K	0.350	0.380	8.89	9.65	
R	0.175	0.215	4.45	5.46	
S	0.050	0.090	1.27	2.28	
V	0.030	0.050	0.77	1.27	

STYLE 6: PIN 1. MT1 2. MT2 3. GATE 4. MT2

D-PAK CASE 369A-13 **ISSUE Z**



- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.

	INCHES		MILLIMETERS			
DIM	MIN	MAX	MIN	MAX		
Α	0.235	0.250	5.97	6.35		
В	0.250	0.265	6.35	6.73		
С	0.086	0.094	2.19	2.38		
D	0.027	0.035	0.69	0.88		
Ε	0.033	0.040	0.84	1.01		
F	0.037	0.047	0.94	1.19		
G	0.180 BSC		4.58 BSC			
Н	0.034	0.040	0.87	1.01		
J	0.018	0.023	0.46	0.58		
K	0.102	0.114	2.60	2.89		
L	0.090	BSC	2.29 BSC			
R	0.175	0.215	4.45	5.46		
S	0.020	0.050	0.51	1.27		
U	0.020		0.51			
٧	0.030	0.050	0.77	1.27		
7	N 120		3 51			

STYLE 6: PIN 1. MT1 2. MT2 3. GATE 4. MT2

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affliliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer.

PUBLICATION ORDERING INFORMATION

NORTH AMERICA Literature Fulfillment:

Literature Distribution Center for ON Semiconductor P.O. Box 5163, Denver, Colorado 80217 USA

Phone: 303–675–2175 or 800–344–3860 Toll Free USA/Canada **Fax**: 303–675–2176 or 800–344–3867 Toll Free USA/Canada

Email: ONlit@hibbertco.com

Fax Response Line: 303-675-2167 or 800-344-3810 Toll Free USA/Canada

N. American Technical Support: 800-282-9855 Toll Free USA/Canada

EUROPE: LDC for ON Semiconductor - European Support

German Phone: (+1) 303-308-7140 (M-F 1:00pm to 5:00pm Munich Time)

Email: ONlit-german@hibbertco.com

French Phone: (+1) 303–308–7141 (M–F 1:00pm to 5:00pm Toulouse Time)

Email: ONlit-french@hibbertco.com

English Phone: (+1) 303–308–7142 (M–F 12:00pm to 5:00pm UK Time)

Email: ONlit@hibbertco.com

EUROPEAN TOLL-FREE ACCESS*: 00-800-4422-3781

*Available from Germany, France, Italy, England, Ireland

CENTRAL/SOUTH AMERICA:

Spanish Phone: 303-308-7143 (Mon-Fri 8:00am to 5:00pm MST)

Email: ONlit-spanish@hibbertco.com

ASIA/PACIFIC: LDC for ON Semiconductor – Asia Support

Phone: 303–675–2121 (Tue–Fri 9:00am to 1:00pm, Hong Kong Time)

Toll Free from Hong Kong & Singapore: 001–800–4422–3781

Email: ONlit-asia@hibbertco.com

JAPAN: ON Semiconductor, Japan Customer Focus Center 4–32–1 Nishi–Gotanda, Shinagawa–ku, Tokyo, Japan 141–0031

Phone: 81–3–5740–2745 **Email**: r14525@onsemi.com

ON Semiconductor Website: http://onsemi.com

For additional information, please contact your local Sales Representative.